

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	RESUBMISSION
NATURE OF CONVEYANCE:	ASSIGNMENT
RESUBMIT DOCUMENT ID:	506234465
CONVEYING PARTY DATA	
Name	Execution Date
KA CHEUNG KWOK	08/21/2020
KWAN WAI TO	08/21/2020
WANG KIN FUNG	08/21/2020
ALEXANDER CROLLA	08/26/2020
STEFANIE MERTENS	08/26/2020
RECEIVING PARTY DATA	
Name:	BELUN TECHNOLOGY (IP) COMPANY LIMITED
Street Address:	FLAT 47, 15/F, BLOCK F, WAH LOK INDUSTRIAL CTR PH II
Internal Address:	31-35 SHAN MEI STREET
City:	SHATIN, NT
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29749068
CORRESPONDENCE DATA	
Fax Number:	(202)754-9829
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-349-1690
Email:	mail@marqueziplaw.com
Correspondent Name:	JUAN CARLOS A. MARQUEZ
Address Line 1:	MARQUEZ INTELLECTUAL PROPERTY OFFICE
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ATTORNEY DOCKET NUMBER:	BLNT-0007
NAME OF SUBMITTER:	JUAN CARLOS A. MARQUEZ
SIGNATURE:	/juan.carlos.a.marquez/
DATE SIGNED:	12/29/2020

Total Attachments: 4

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ASSIGNMENT

WHEREAS, I/We, whose names and post office addresses appear below hereinafter referred to as ASSIGNOR, have invented certain new and useful improvements in Healthcare Device (hereinafter referred to as THE INVENTION) which I/We made, contributed to the making and/or authorized the making of an application for the above-noted subject matter which is claimed and for which a patent is sought on the invention (design, if applicable) and I/We believe that I/We are the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a United States Letters Patent is sought on the invention (design, if applicable);

WHEREAS, an application for United States Letters Patent or for priority under International Convention for the above-noted subject matter is being filed concurrently herewith, or was filed on 3/Mar/2020, under Application Number 2015683.8 with the Intellectual Property Department of The Government of the Hong Kong Special Administrative Region;

WHEREAS, BELUN TECHNOLOGY (IP) COMPANY LIMITED, whose post office address is Flat 47, 15/F, Block F, Wah Lok Industrial Ctr Ph II, 31-35 Shan Mei Street, Shatin, NT, Hong Kong (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

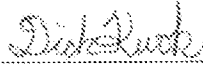
NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

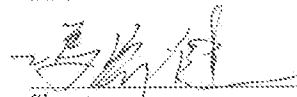
ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR hereby declares that all statements made herein of my/our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine, or imprisonment, or both, under *Section 1001 of Title 18 of the United States Code*, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

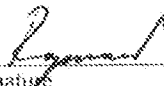
NAME: KWOK, Ka Cheung
ADDRESS:
Unit 218, 2/F, Core Building 2
No. 1 Science Park West Avenue, Hong Kong Science Park,
Shatin, New Territories, Hong Kong


Signature
21/8/2020
Date

NAME: FUNG, Wang Kin
ADDRESS:
Unit 218, 2/F, Core Building 2
No. 1 Science Park West Avenue, Hong Kong Science Park,
Shatin, New Territories, Hong Kong


Signature
21/8/2020
Date

NAME: TO, Kwan Wai
ADDRESS:
Unit 218, 2/F, Core Building 2
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Shatin, New Territories, Hong Kong


Signature
21/8/2020
Date

NAME: CROLLA, Alexander
ADDRESS:
Boomgaardsstraat 115
2018 Antwerp
Belgium

Signature

Date

NAME: MERTENS, Stefanie
ADDRESS:
Boomgaardsstraat 115
2018 Antwerp
Belgium

Signature

Date

ASSIGNMENT

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NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

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NAME: KWOK, Ka Cheung

ADDRESS:

Unit 218, 2/F, Core Building 2

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Signature

Date

NAME: FUNG, Wang Kin

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Date

NAME: TO, Kwan Wai

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Date

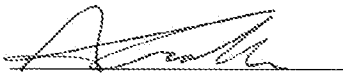
NAME: CROLLA, Alexander

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2018 Antwerp

Belgium



Signature

26-08-2020

Date

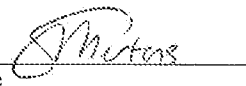
NAME: MERTENS, Stefanie

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Boomgaardstraat 115

2018 Antwerp

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Signature

26-08-2020

Date